



高端电力电子器件和装置制造商

CSG10F4500

门极可关断晶闸管

应用

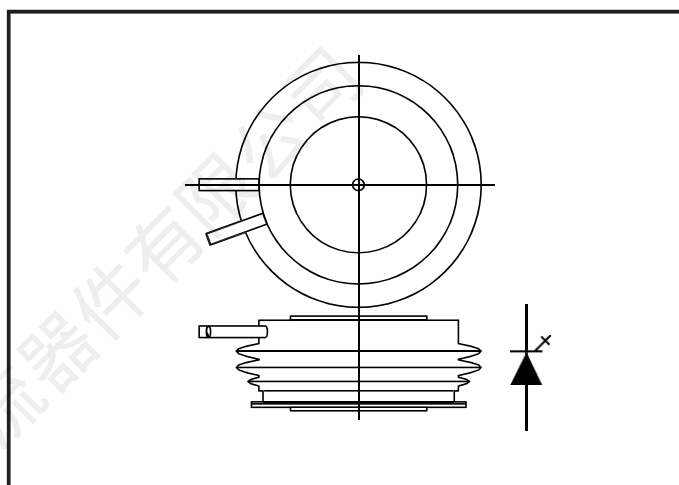
- 变速交流电机驱动逆变器(VSD-AC)
- 不间断电源
- 高电压转换器
- 斩波器
- 电焊机
- 感应加热
- DC / DC 转换器

关键参数

I_{TCM}	1000A
V_{DRM}	4500V
$I_{T(AV)}$	320A
dV_D/dt	1000V/ μ s
di_T/dt	300A/ μ s

特性

- 双面散热
- 可靠性高
- 高压性能
- 无快熔故障保护
- 大浪涌电流性能
- 关断性能可减少设备尺寸和重量，环保低噪音



Outline type code: P.
See Package Details for further information.

电压等级

型号	断态重复峰值电压 V_{DRM}	反向重复峰值电压 V_{RRM}	测试条件
CSG10F4500	4500	16	$T_{vj} = 125^{\circ}\text{C}$, $I_{DM} = 50\text{mA}$, $I_{RRM} = 50\text{mA}$

电流等级

符号	参数	测试条件	Max.	单位
I_{TCM}	Repetitive peak controllable on-state current	$V_D = V_{DRM}$, $T_j = 125^{\circ}\text{C}$, $di/dt = 30\text{A}/\mu\text{s}$, $C_s = 1.0\mu\text{F}$ GQ	1000	A
$I_{T(AV)}$	Mean on-state current	$T_{HS} = 80^{\circ}\text{C}$. Double side cooled. Half sine 50Hz.	320	A
$I_{T(RMS)}$	RMS on-state current	$T_{HS} = 80^{\circ}\text{C}$. Double side cooled. Half sine 50Hz.	500	A

浪涌等级

符号	参数	测试条件	Max.	单位
I_{TSM}	Surge (non-repetitive) on-state current	10ms half sine. $T_j = 125^\circ\text{C}$	7.0	kA
I^2t	I^2t for fusing	10ms half sine. $T_j = 125^\circ\text{C}$	0.245×10^6	A^2s
di_T/dt	Critical rate of rise of on-state current	$V_D = 3000\text{V}$, $I_T = 1000\text{A}$, $T_j = 125^\circ\text{C}$, $I_{FG} > 30\text{A}$, Rise time $> 1.5\mu\text{s}$	300	$\text{A}/\mu\text{s}$
dV_D/dt	Rate of rise of off-state voltage	To 66% V_{DRM} ; $R_{GK} \leq 1.5\Omega$, $T_j = 125^\circ\text{C}$	225	$\text{V}/\mu\text{s}$
		To 66% V_{DRM} ; $V_{RG} = -2\text{V}$, $T_j = 125^\circ\text{C}$	1000	$\text{V}/\mu\text{s}$
L_S	Peak stray inductance in snubber circuit	-	200	nH

门极等级

符号	参数	测试条件	Min.	Max.	单位
V_{RGM}	Peak reverse gate voltage	This value maybe exceeded during turn-off	-	16	V
I_{FGM}	Peak forward gate current		20	70	A
$P_{FG(AV)}$	Average forward gate power		-	10	W
P_{RGM}	Peak reverse gate power		-	15	kW
di_{GQ}/dt	Rate of rise of reverse gate current		15	60	$\text{A}/\mu\text{s}$
$t_{ON(min)}$	Minimum permissible on time		20	-	μs
$t_{OFF(min)}$	Minimum permissible off time		100	-	μs

热力和力学参数

符号	参数	测试条件		Min.	Max.	单位
$R_{th(j-hs)}$	DC thermal resistance - junction to heatsink surface	Double side cooled		-	0.041	$^\circ\text{C}/\text{W}$
		Anode side cooled		-	0.07	$^\circ\text{C}/\text{W}$
		Cathode side cooled		-	0.1	$^\circ\text{C}/\text{W}$
$R_{th(c-hs)}$	Contact thermal resistance	Clamping force 12.0kN With mounting compound	per contact	-	0.009	$^\circ\text{C}/\text{W}$
T_{vj}	Virtual junction temperature			-	125	$^\circ\text{C}$
T_{OP}/T_{stg}	Operating junction/storage temperature range			-40	125	$^\circ\text{C}$
-	Clamping force			11.0	15.0	kN

特性

$T_j = 125^\circ\text{C}$ unless stated otherwise

符号	参数	测试条件	Min.	Max.	单位
V_{TM}	On-state voltage	At 1000A peak, $I_{G(ON)} = 4\text{A d.c.}$	-	3.5	V
I_{DM}	Peak off-state current	$V_{DRM} = 4500\text{V}$, $V_{RG} = 0\text{V}$	-	50	mA
I_{RRM}	Peak reverse current	At V_{RRM}	-	50	mA
V_{GT}	Gate trigger voltage	$V_D = 24\text{V}$, $I_T = 100\text{A}$, $T_j = 25^\circ\text{C}$	-	1.0	V
I_{GT}	Gate trigger current	$V_D = 24\text{V}$, $I_T = 100\text{A}$, $T_j = 25^\circ\text{C}$	-	1.5	A
I_{RGM}	Reverse gate cathode current	$V_{RGM} = 16\text{V}$, No gate/cathode resistor	-	50	mA
E_{ON}	Turn-on energy	$V_D = 3000\text{V}$ $I_T = 1000\text{A}$, $dI_T/dt = 300\text{A}/\mu\text{s}$ $I_{FG} = 30\text{A}$, rise time $< 1.5\mu\text{s}$	-	2300	mJ
t_d	Delay time		-	1.5	μs
t_r	Rise time		-	5.0	μs
E_{OFF}	Turn-off energy	$I_T = 1000\text{A}$, $V_{DM} = V_{DRM}$ Snubber Cap $C_s = 1.0\mu\text{F}$, $di_{GQ}/dt = 30\text{A}/\mu\text{s}$	-	4120	mJ
t_{gs}	Storage time		-	14.0	μs
t_{gf}	Fall time		-	1.5	μs
t_{gq}	Gate controlled turn-off time		-	15.5	μs
Q_{GQ}	Turn-off gate charge		-	3000	μC
Q_{GQT}	Total turn-off gate charge		-	6000	μC
I_{GQM}	Peak reverse gate current		-	420	A

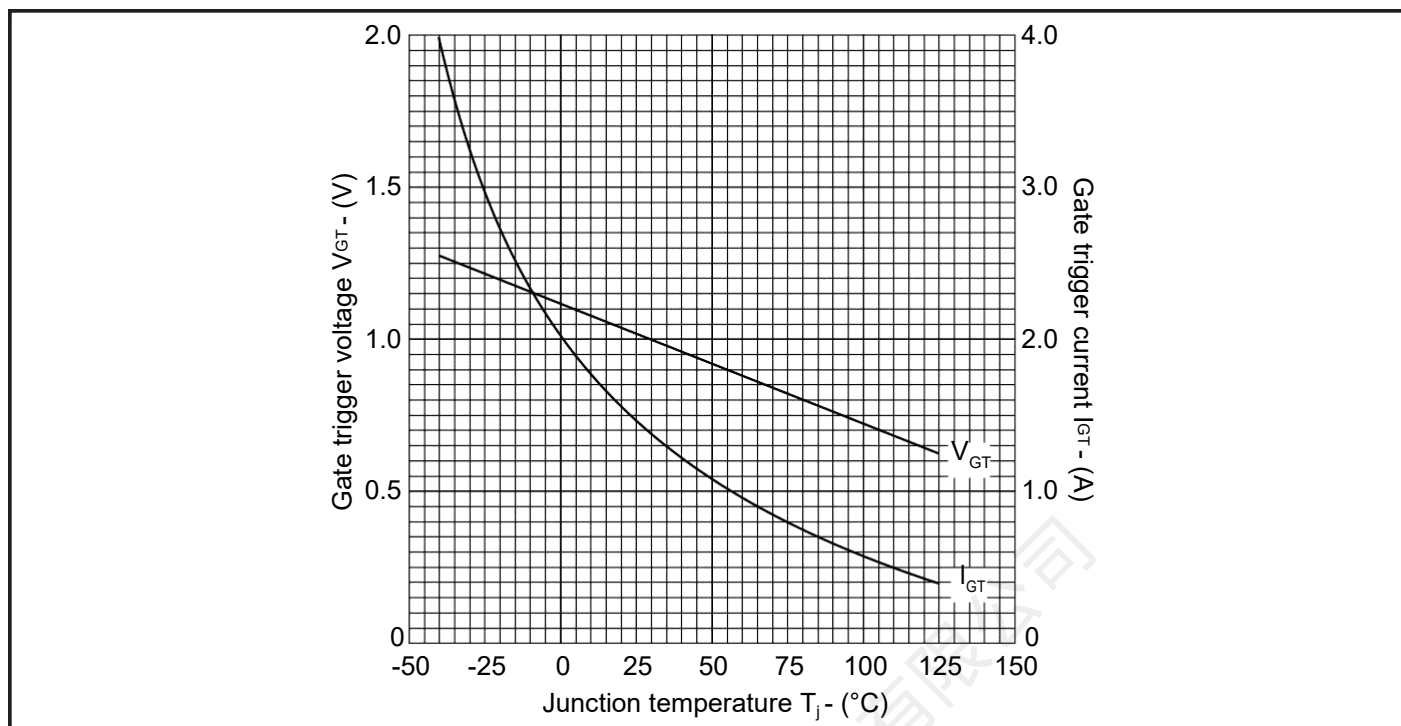


Fig.1 Maximum gate trigger voltage/current vs junction temperature

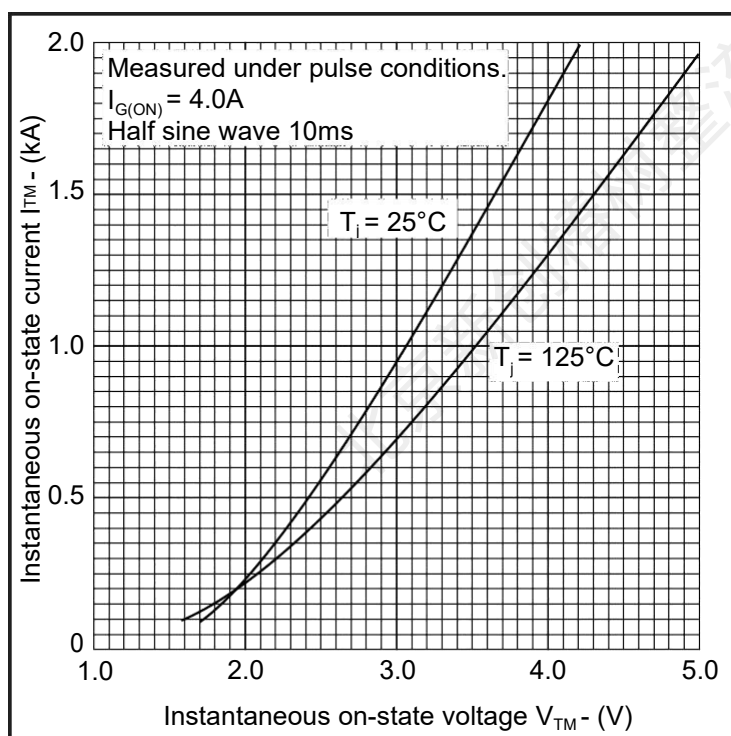


Fig.2 On-state characteristics

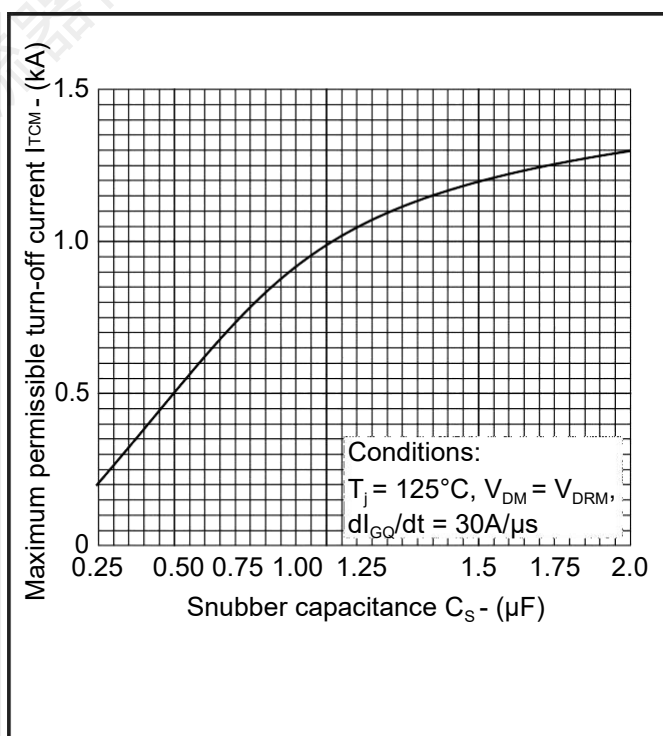


Fig.3 Maximum dependence of I_{TCM} on C_S

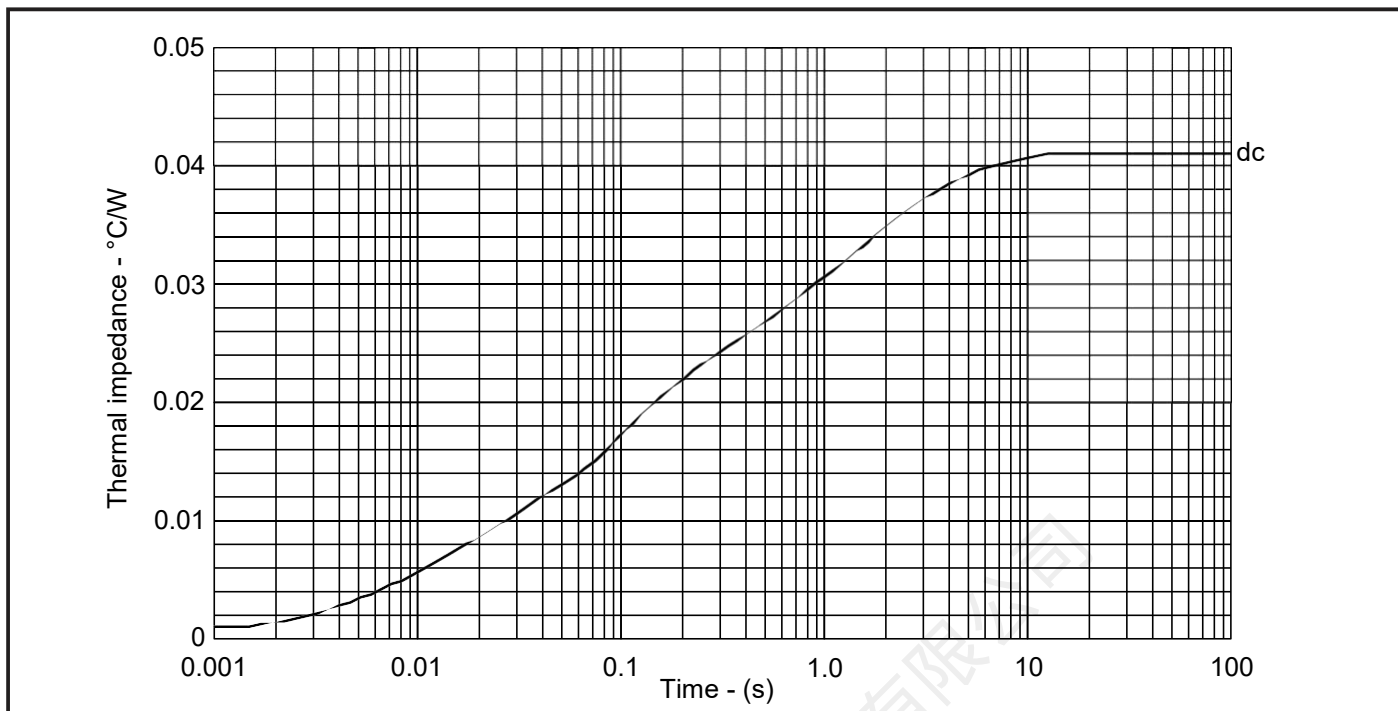


Fig.4 Maximum (limit) transient thermal impedance - double side cooled

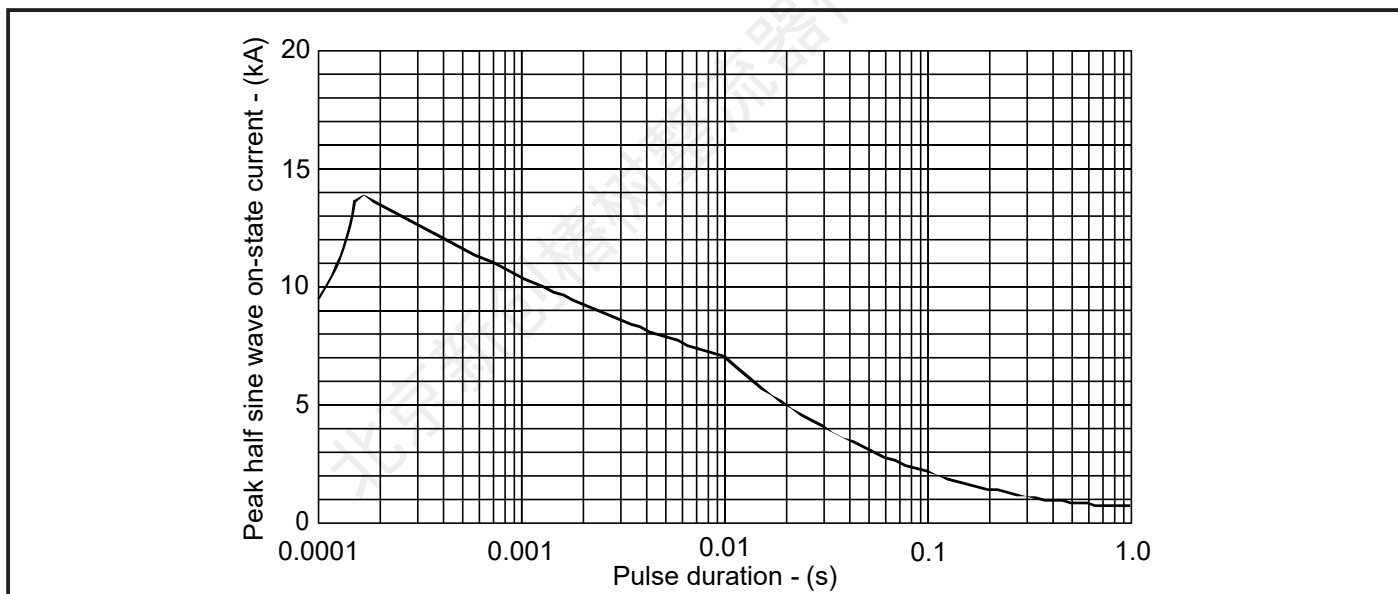


Fig.5 Surge (non-repetitive) on-state current vs time

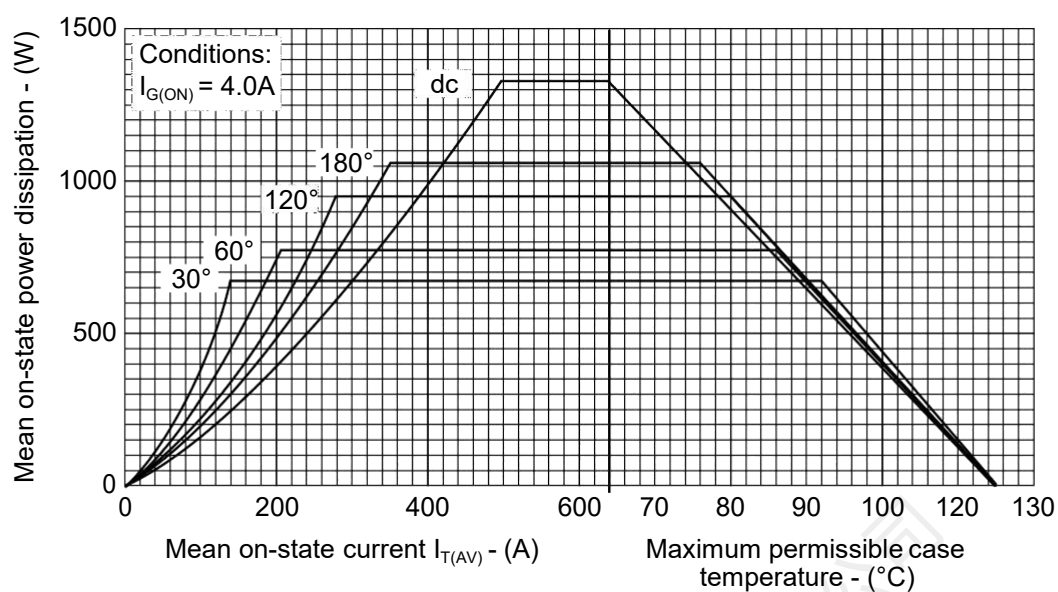


Fig.6 Steady state rectangular wave conduction loss - double side cooled

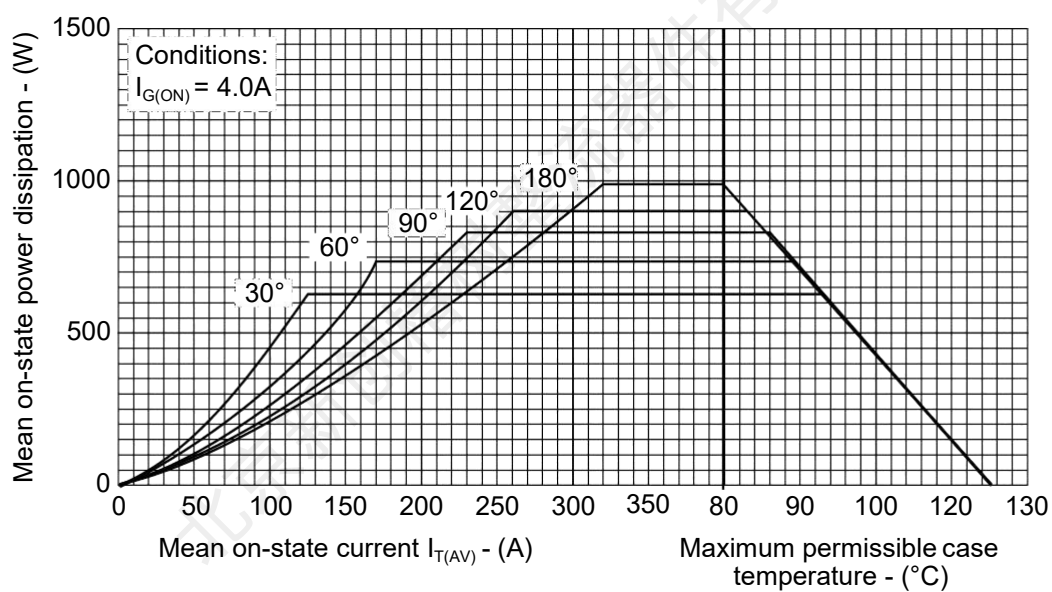


Fig.7 Steady state sinusoidal wave conduction loss - double side cooled

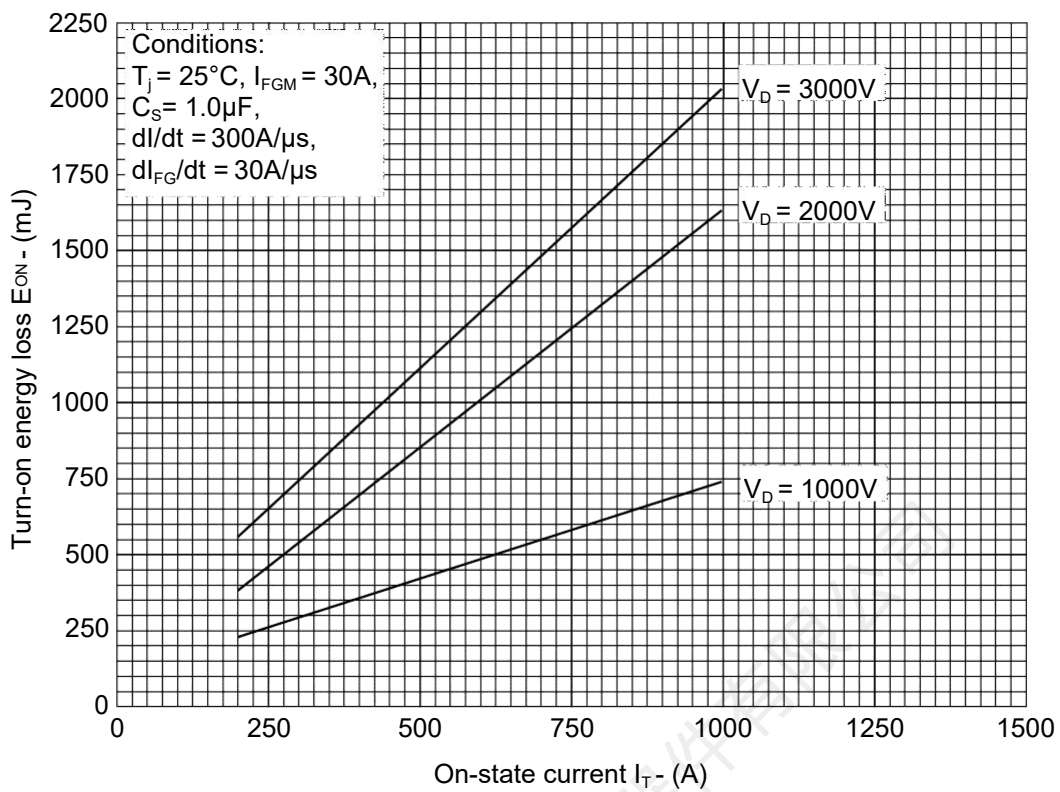


Fig.8 Turn-on energy vs on-state current

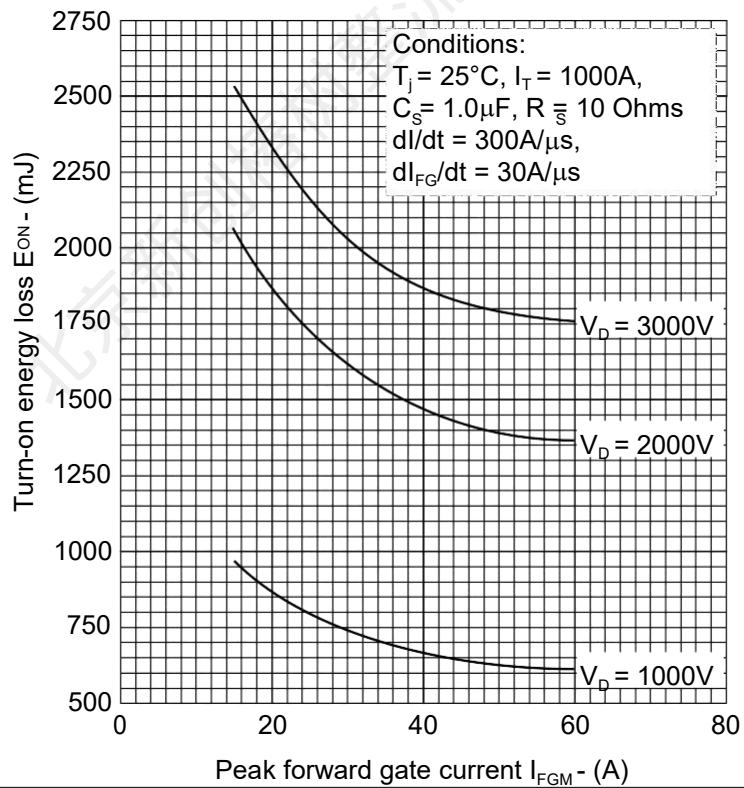


Fig.9 Turn-on energy vs peak forward gate current

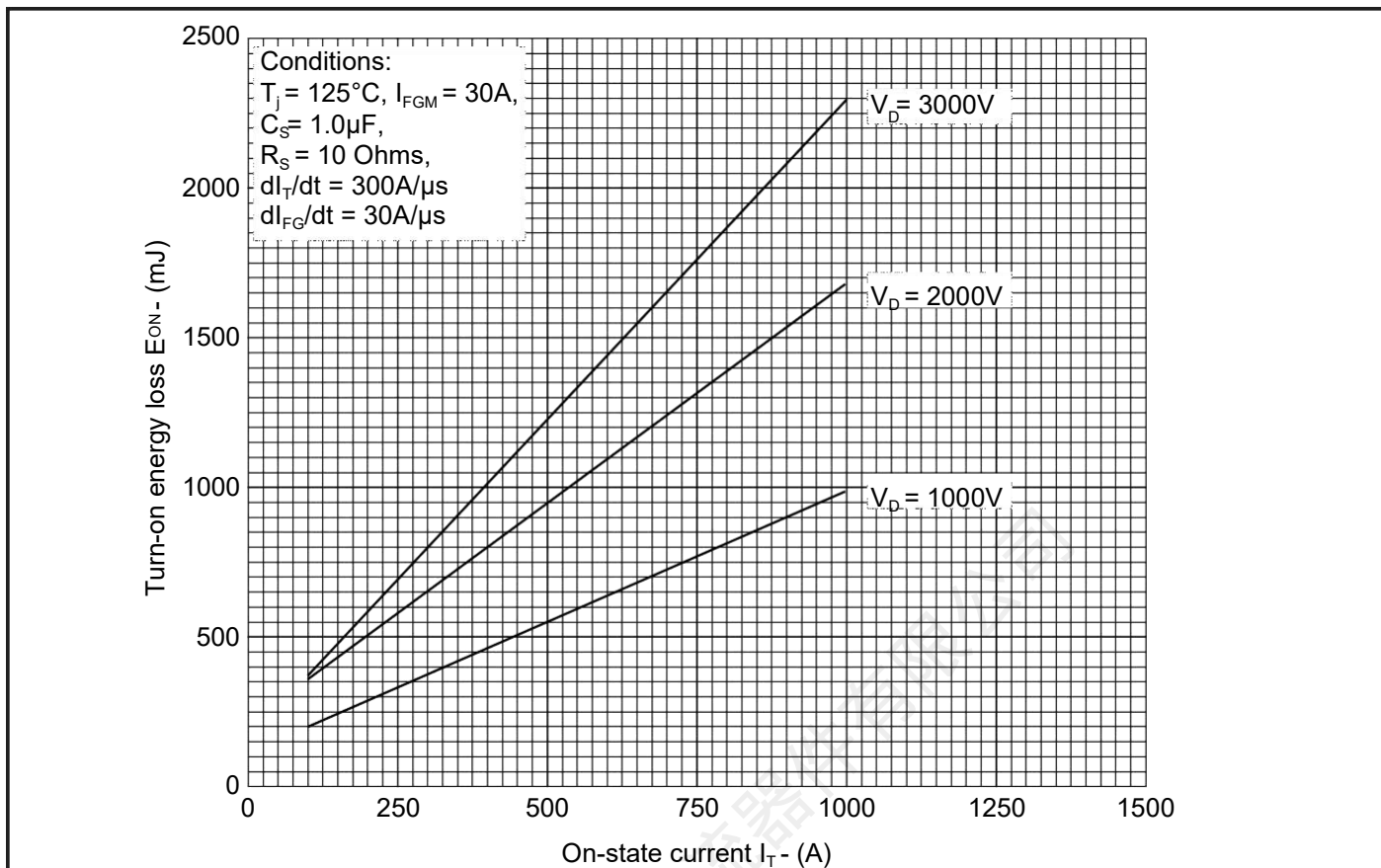


Fig.10 Turn-on energy vs on-state current

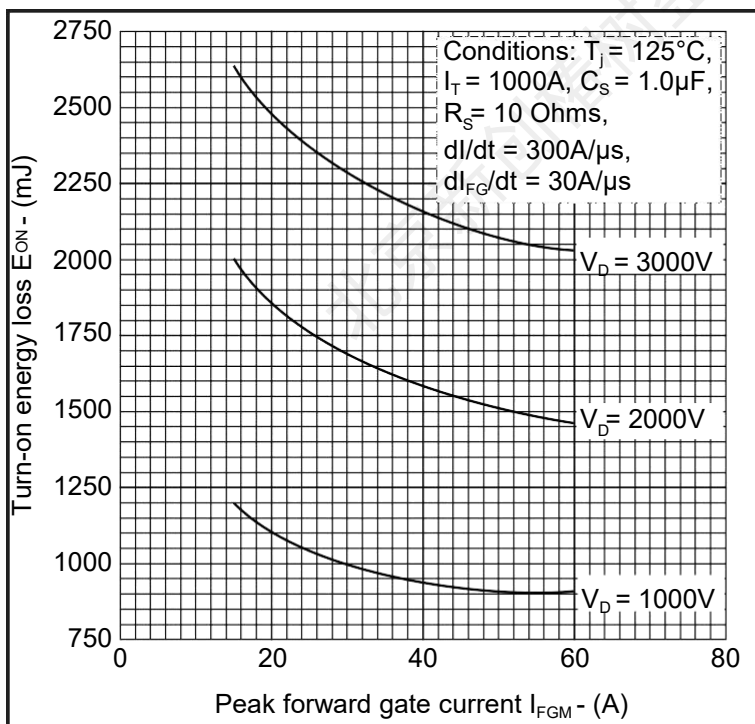


Fig.11 Turn-on energy vs peak forward gate current

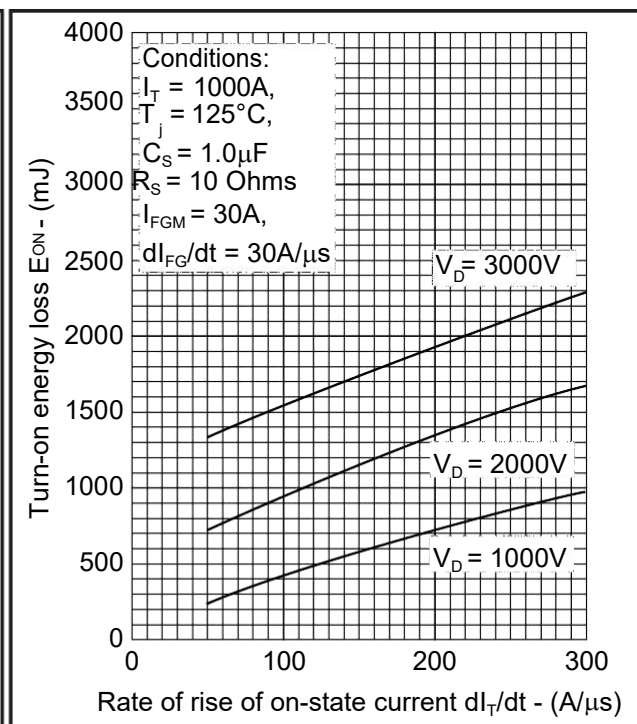


Fig.12 Turn-on energy vs rate of rise of on-state current

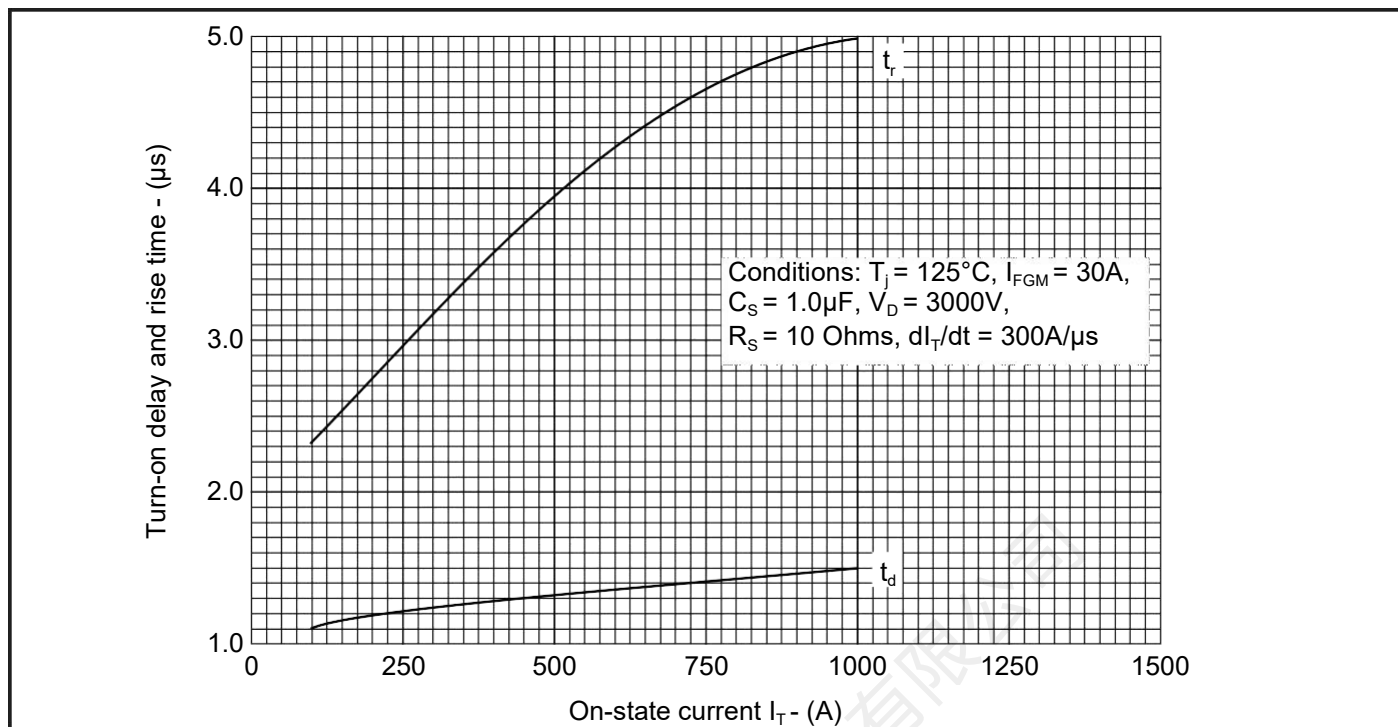


Fig.13 Delay time & rise time vs turn-on current

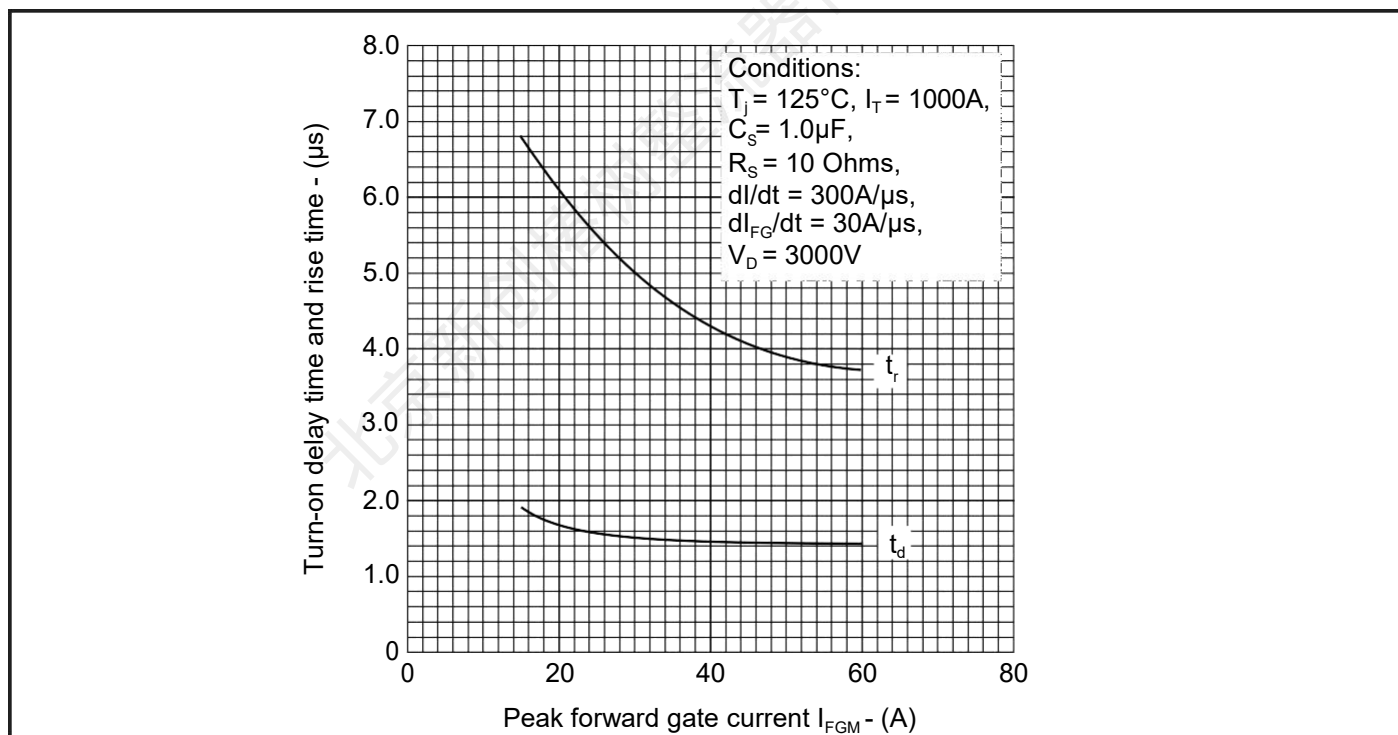


Fig.14 Delay time & rise time vs peak forward gate current

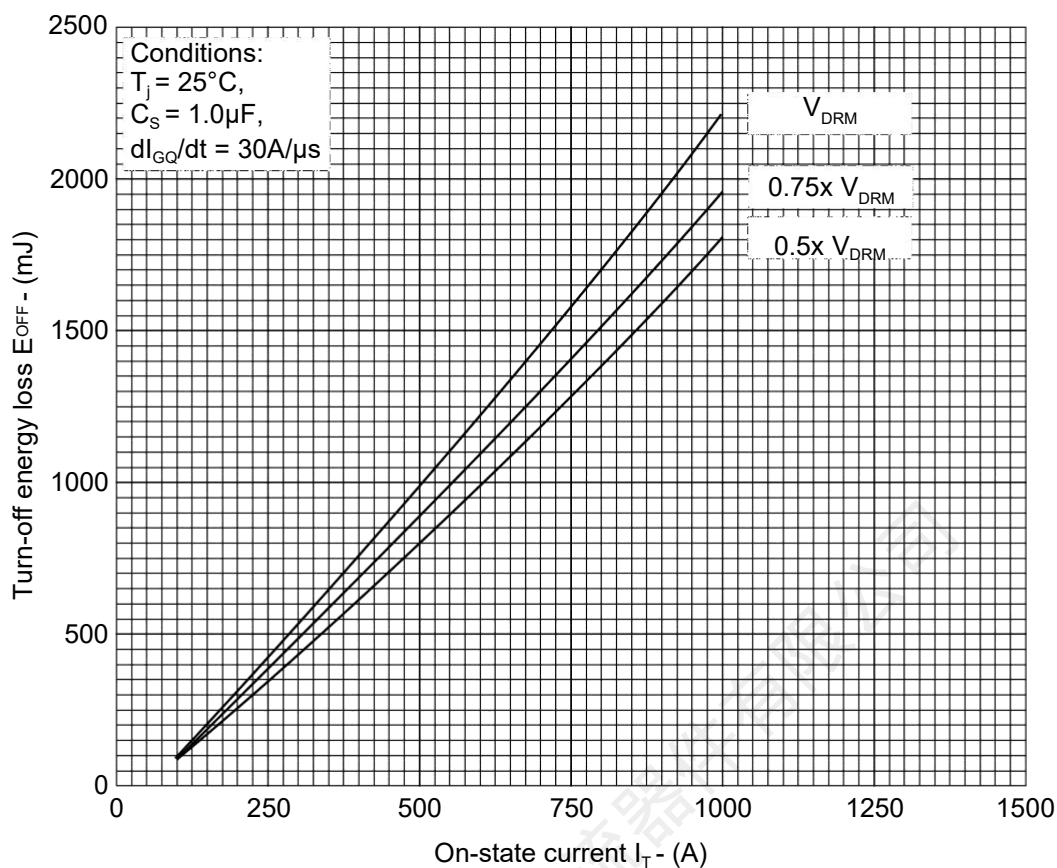


Fig.15 Turn-off energy vs on-state current

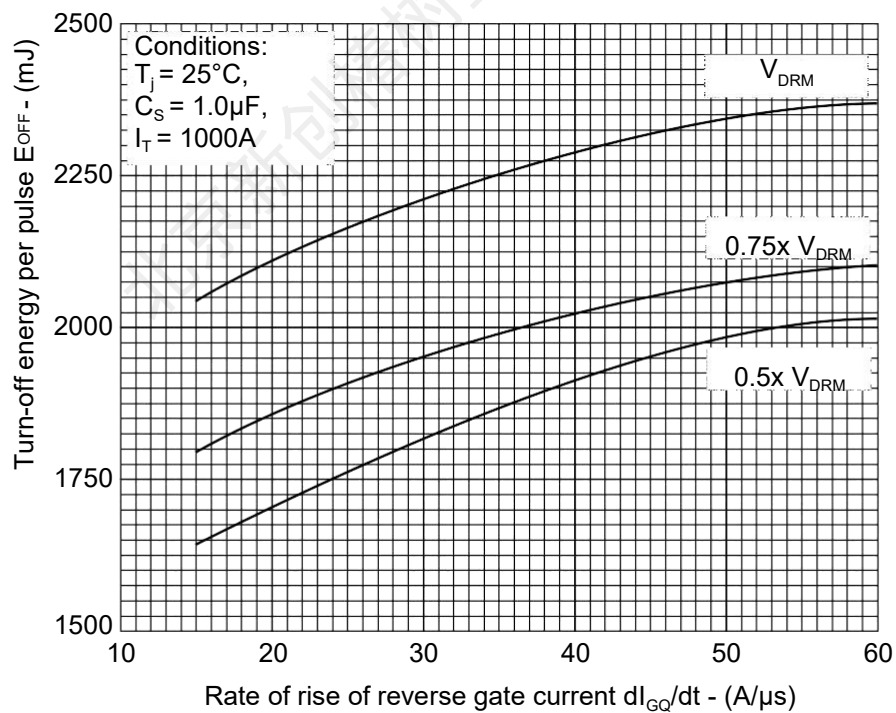


Fig.16 Turn-off energy vs rate of rise of reverse gate current

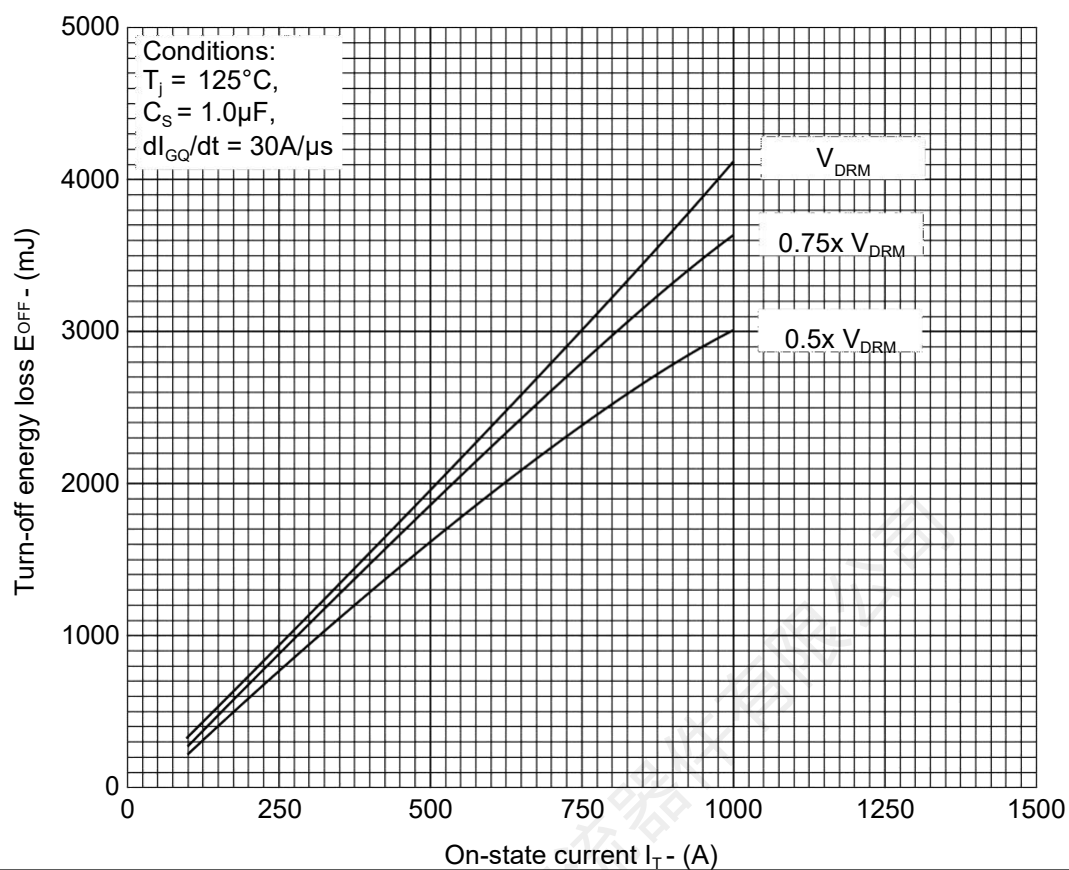


Fig.17 Turn-off energy vs on-state current

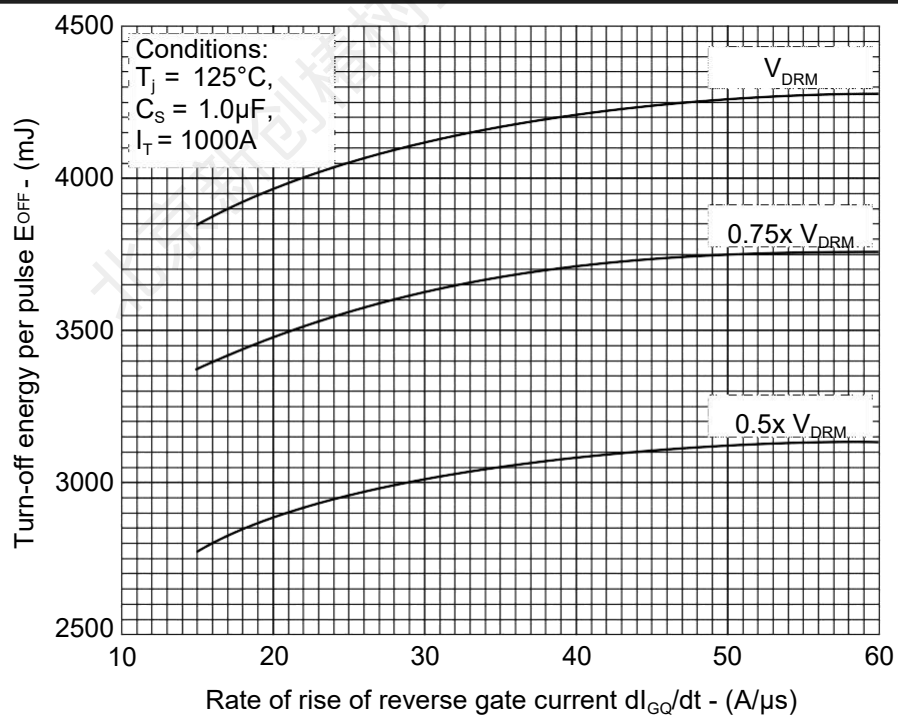


Fig.18 Turn-off energy loss vs rate of rise of reverse gate current

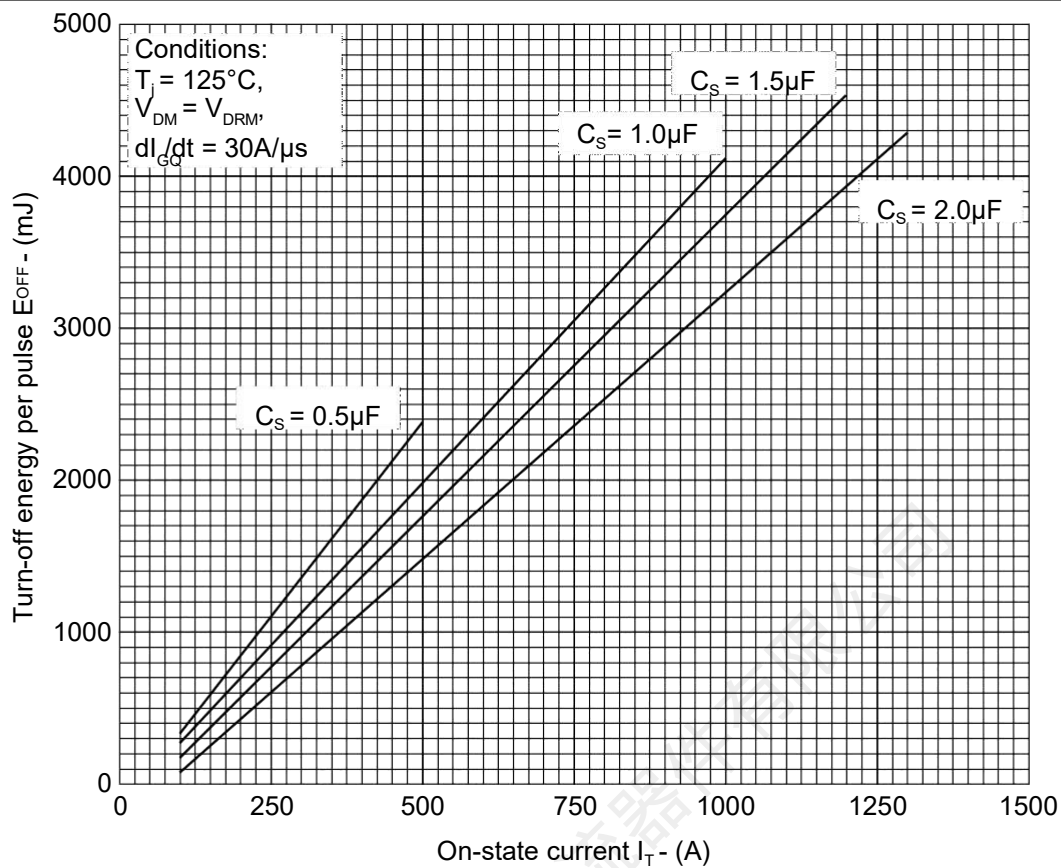


Fig.19 Turn-off energy vs on-state current

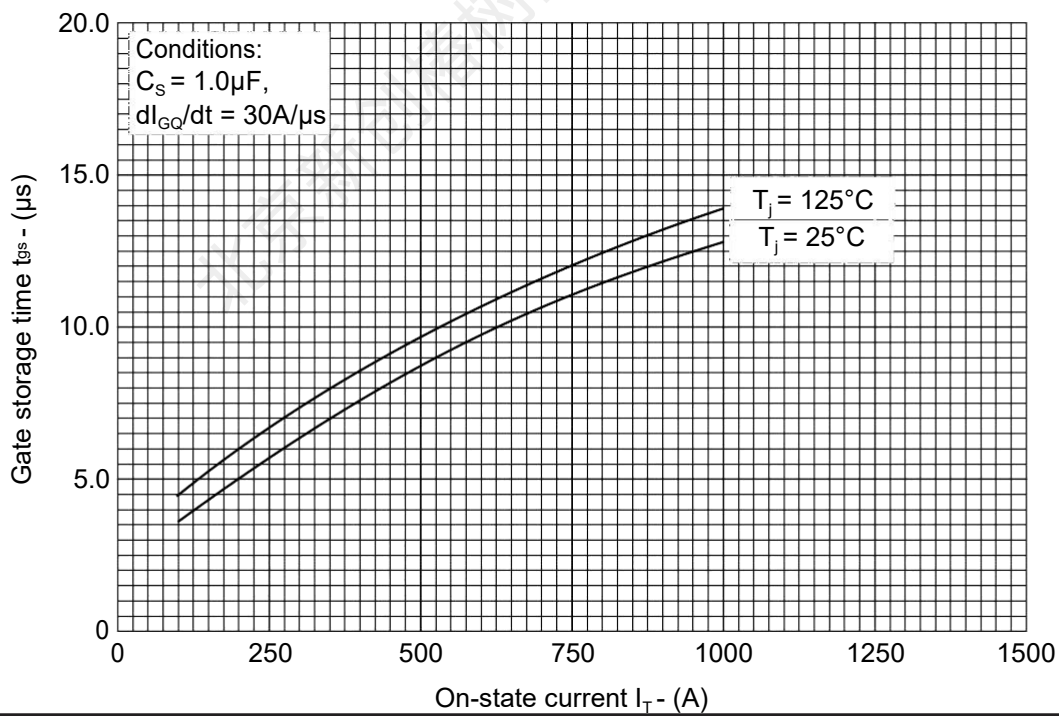


Fig.20 Gate storage time vs on-state current

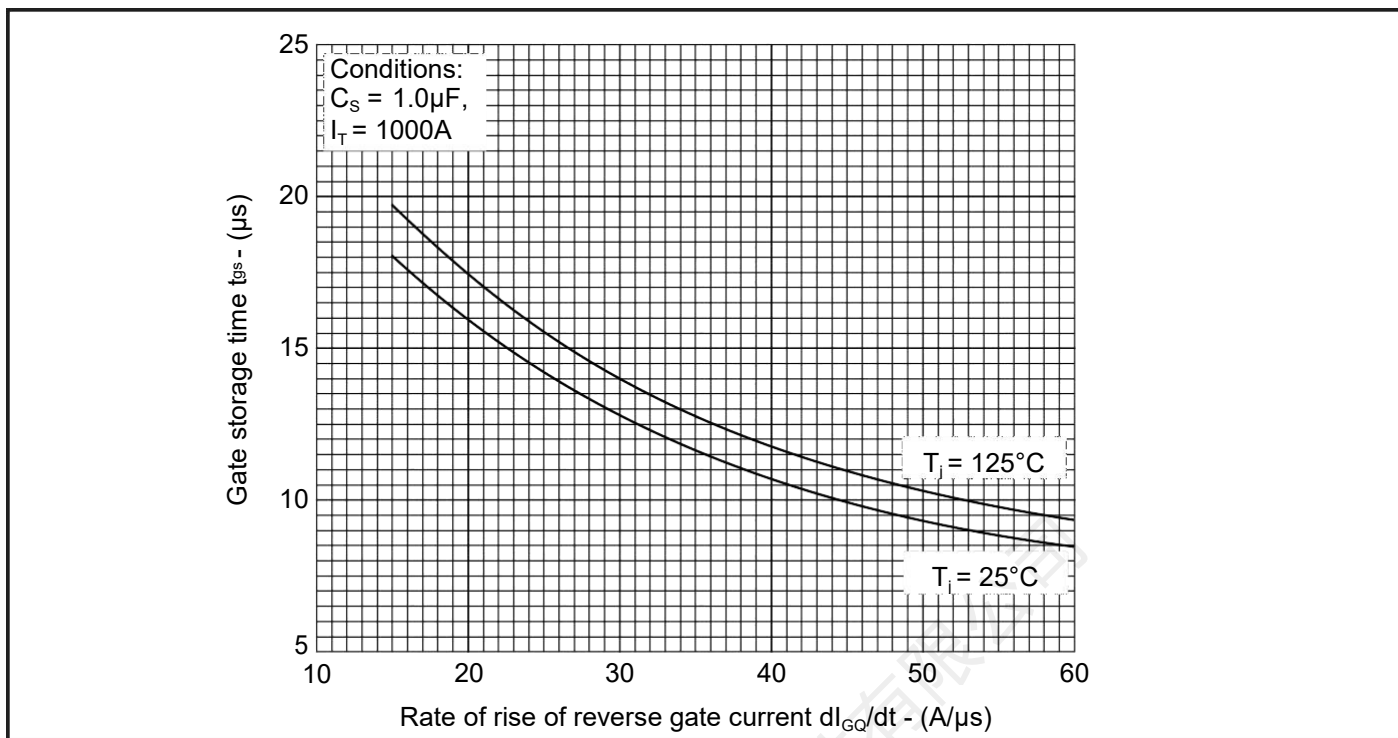


Fig.21 Gate storage time vs rate of rise of reverse gate current

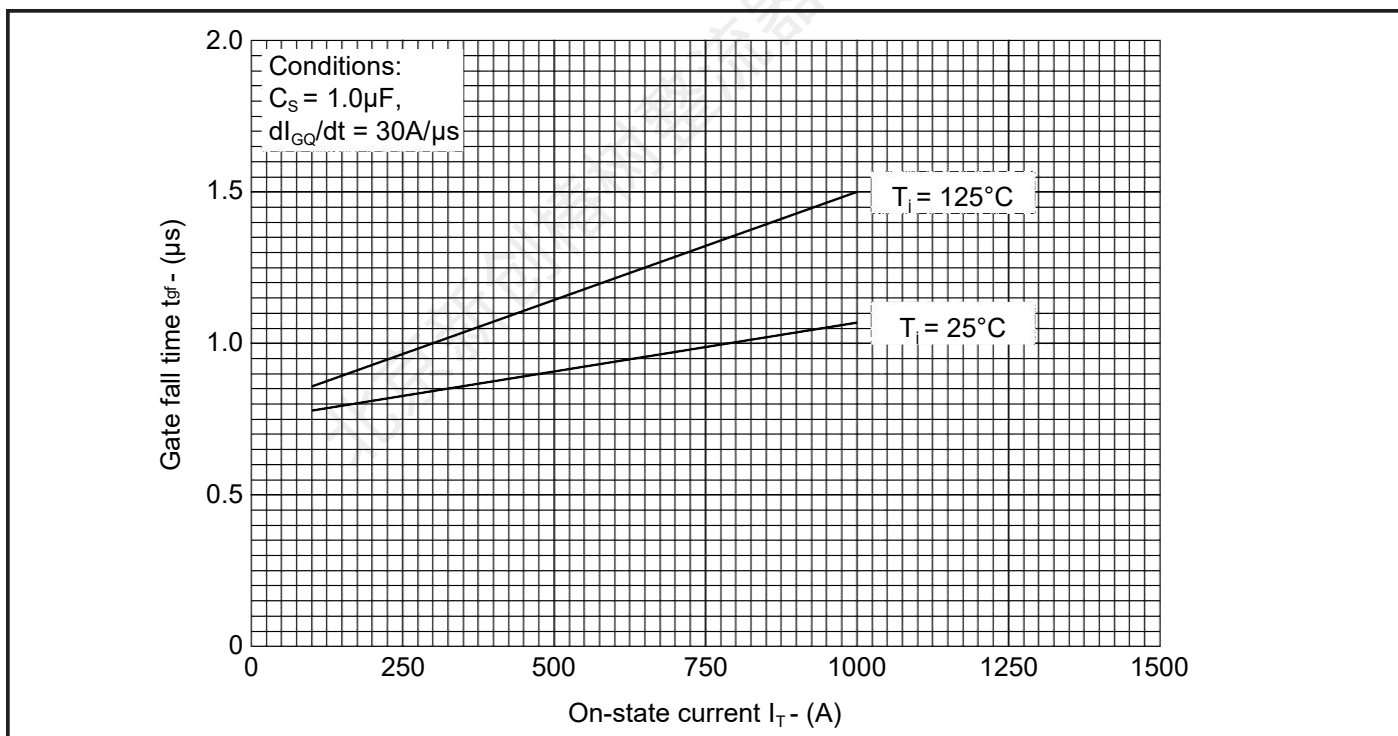


Fig.22 Gate fall time vs on-state current

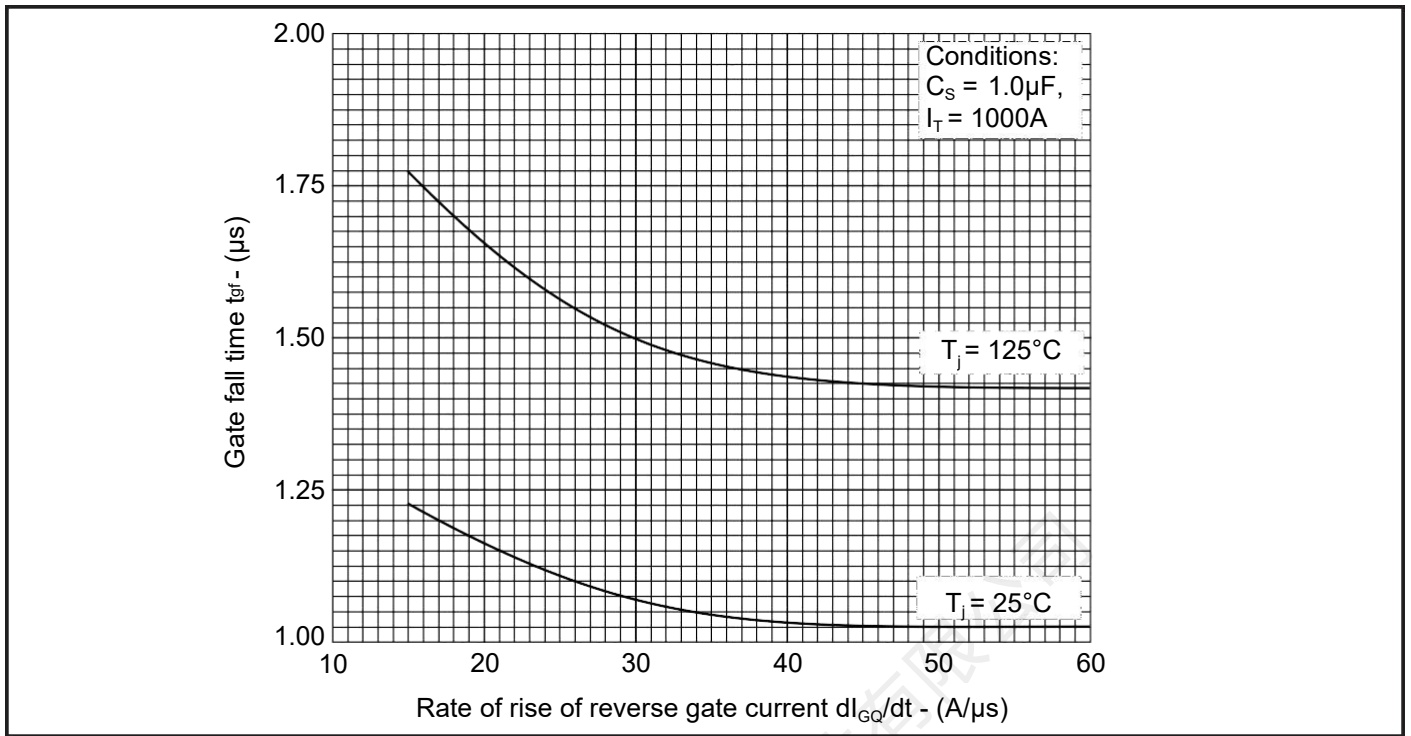


Fig.23 Gate fall time vs rate of rise of reverse gate current

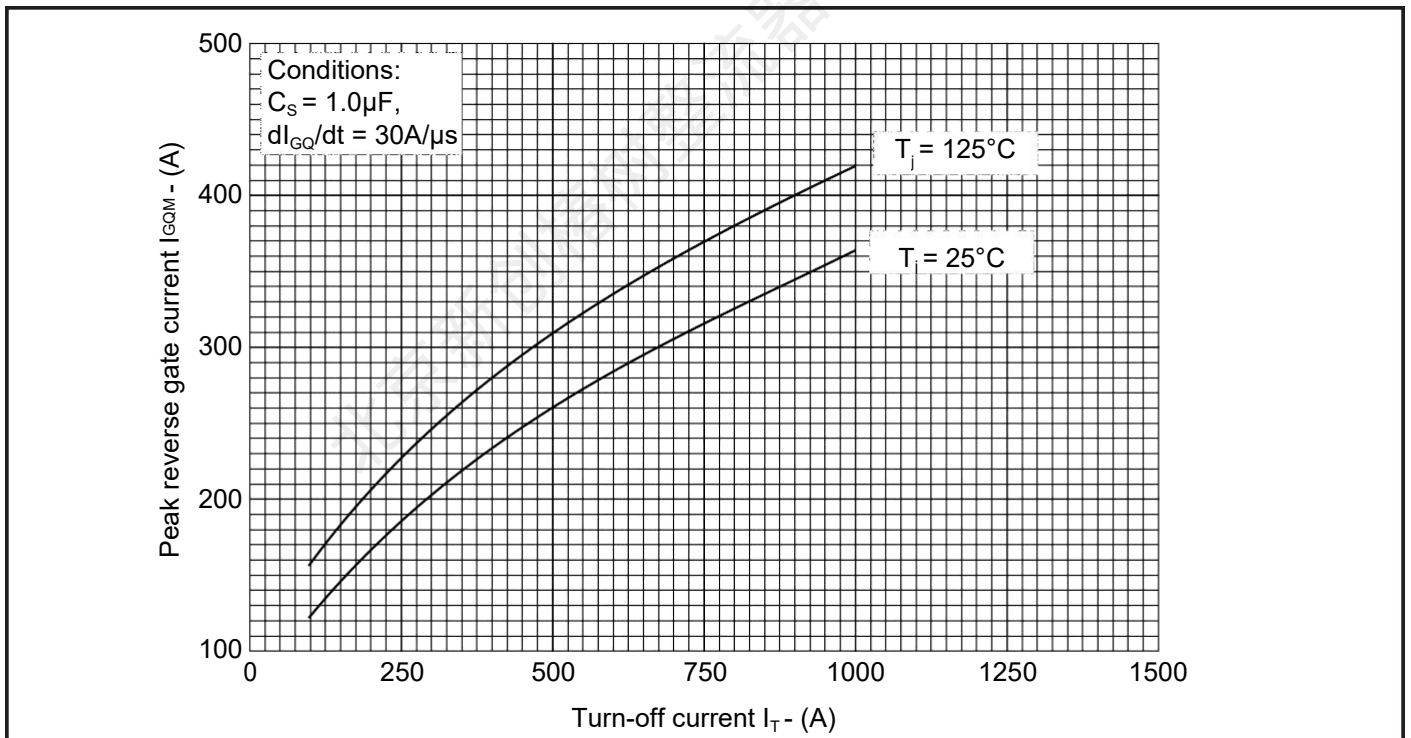


Fig.24 Peak reverse gate current vs turn-off current

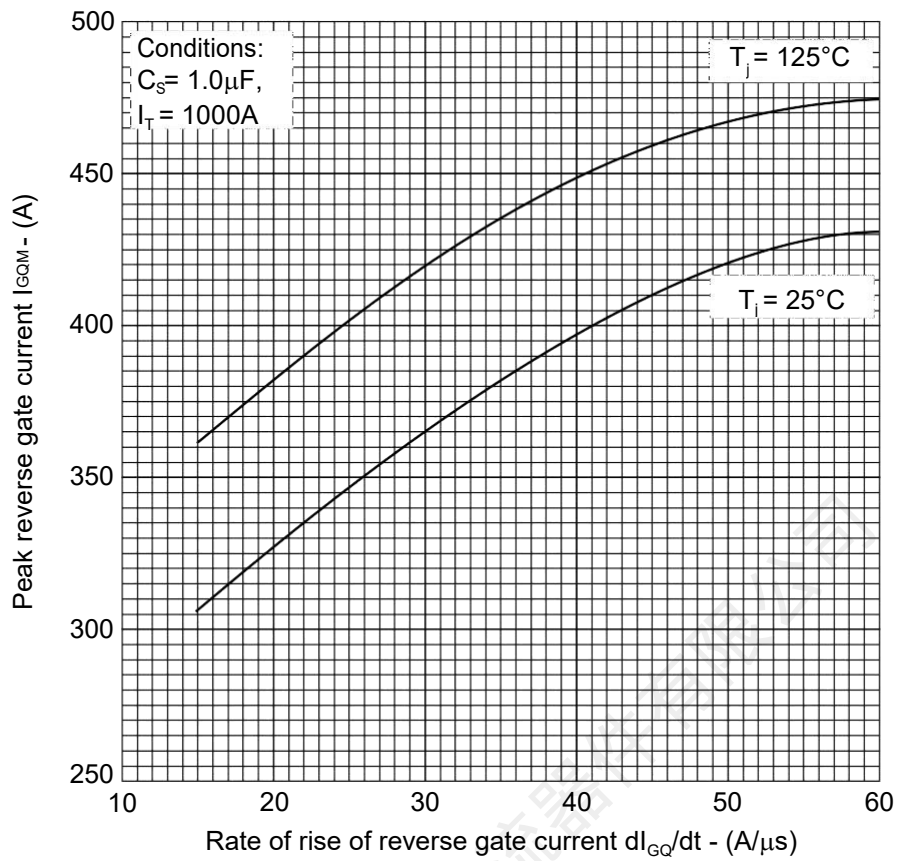


Fig.25 Peak reverse gate current vs rate of rise of reversegate current

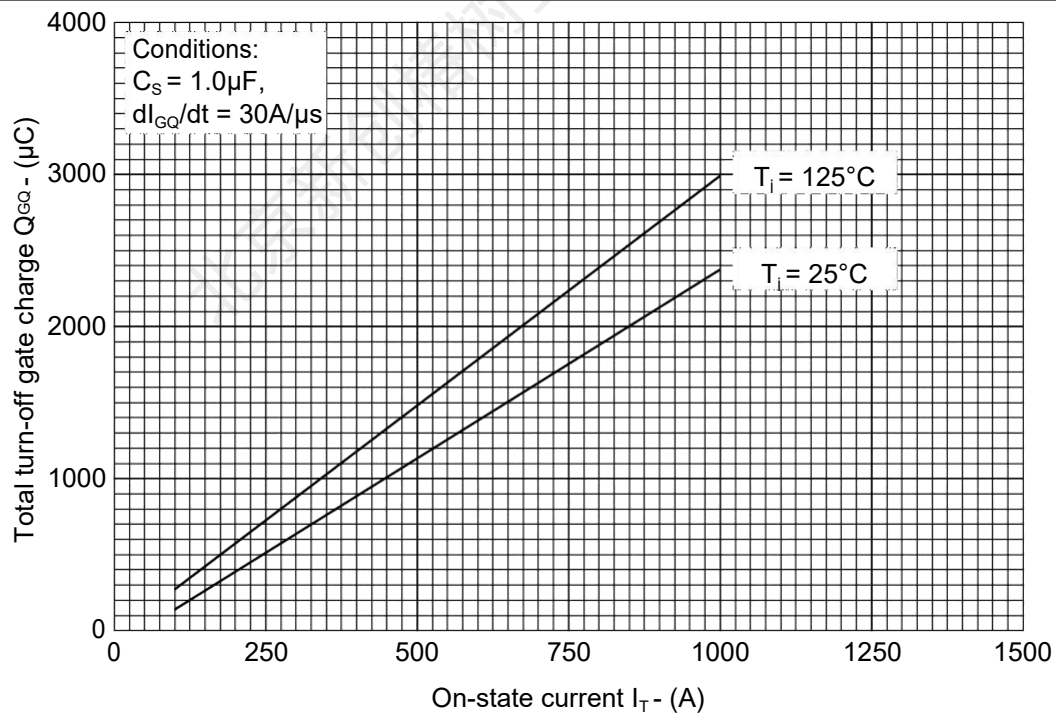


Fig.26 Turn-off gate charge vs on-state current

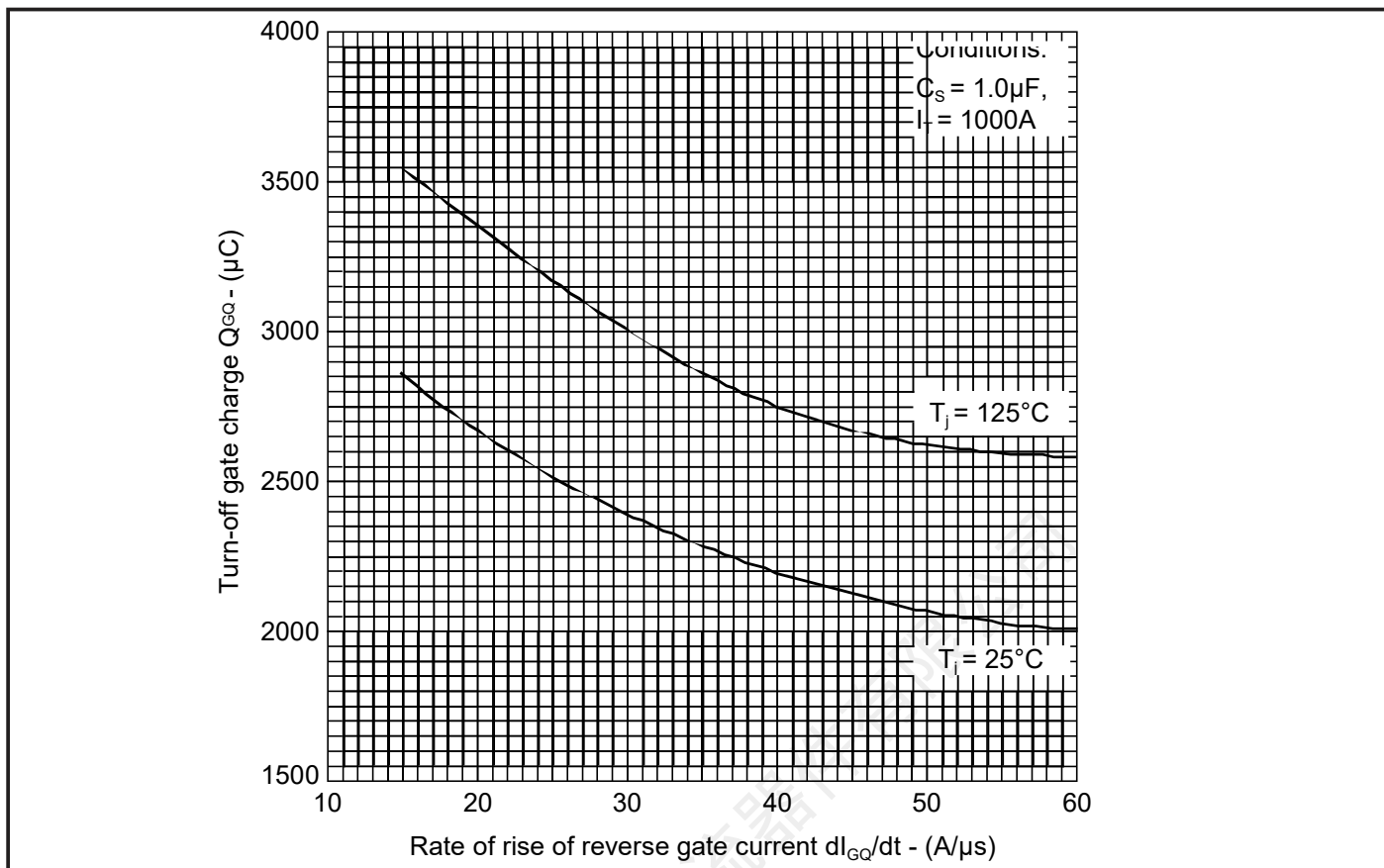


Fig.27 Turn-off gate charge vs rate of rise of reverse gate current

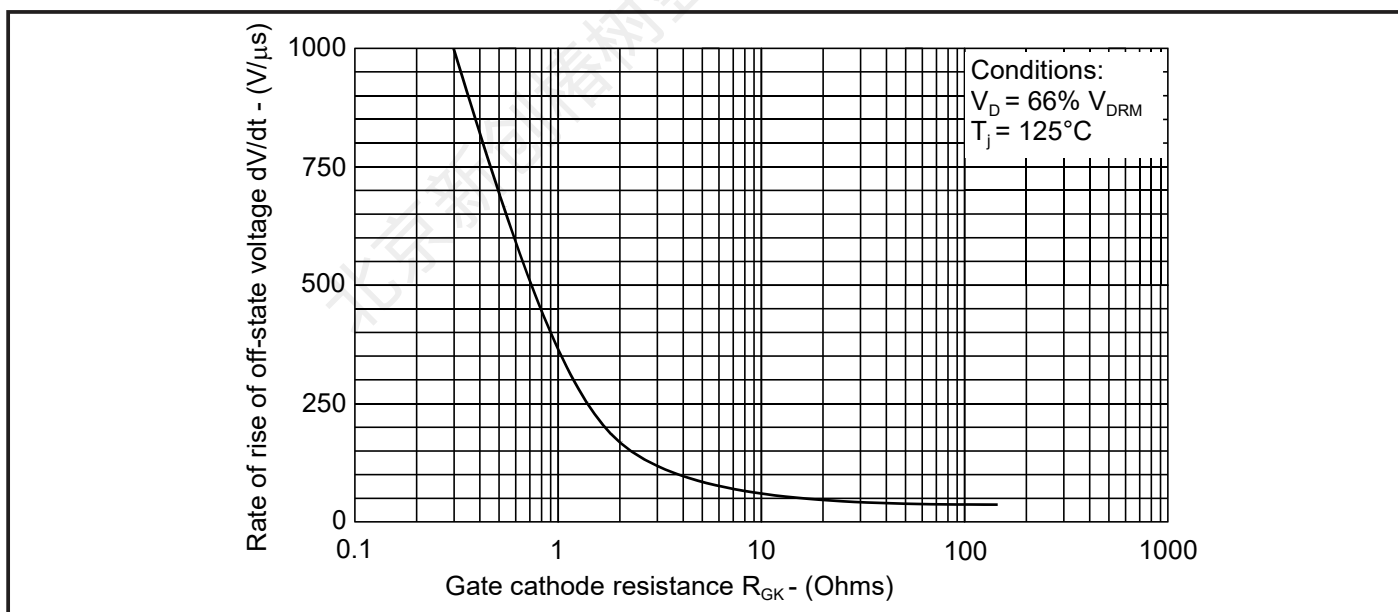
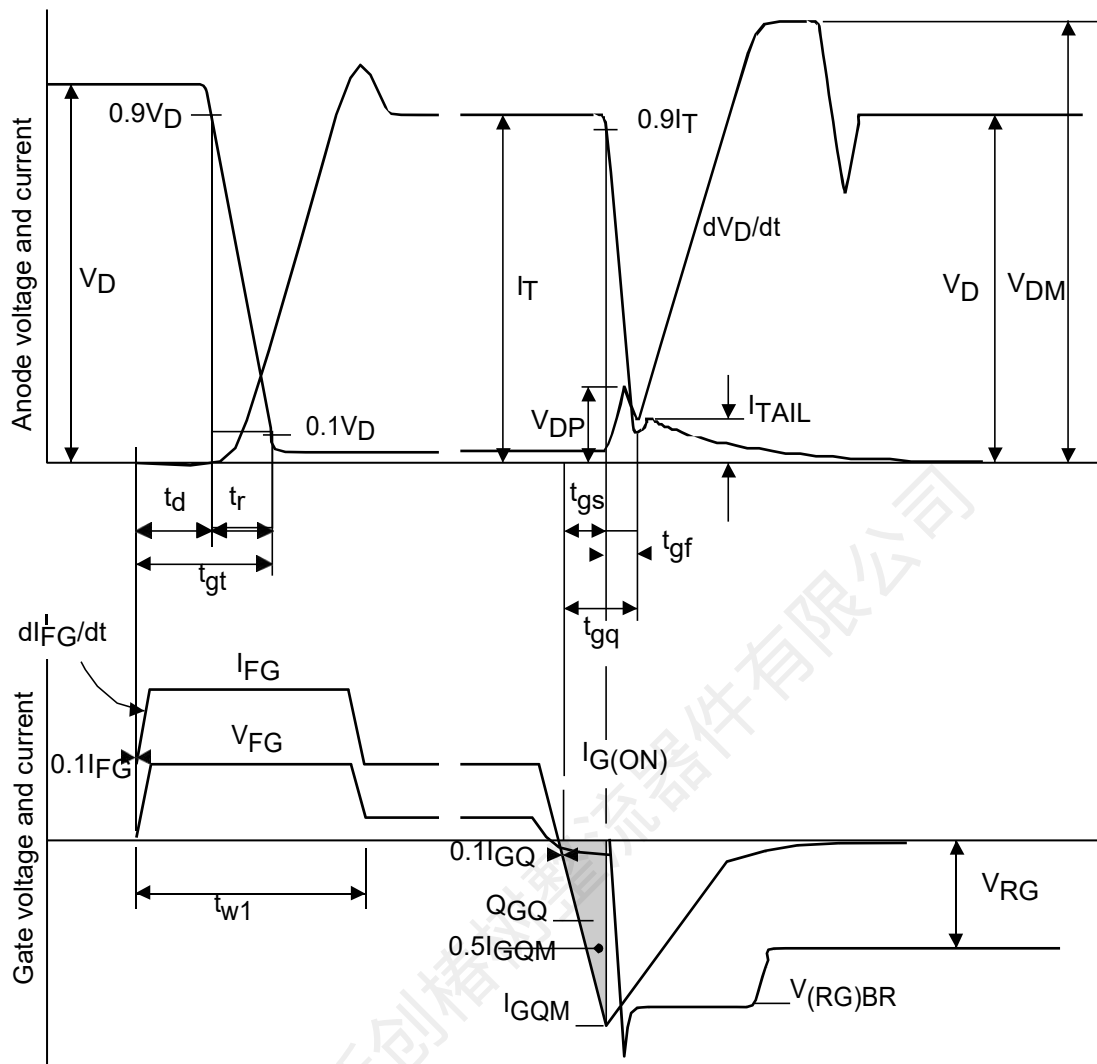


Fig.28 Rate of rise of off-state voltage vs gate cathode resistance



Recommended gate conditions:

$$I_{TCM} = 1000A$$

$$I_{FG} = 30A$$

$$I_{G(ON)} = 4A \text{ d.c.}$$

$$t_{w1(min)} = 20\mu s$$

$$I_{GQM} = 420A$$

$$dI_{GQ}/dt = 30A/\mu s$$

$$Q_{GQ} = 3000\mu C$$

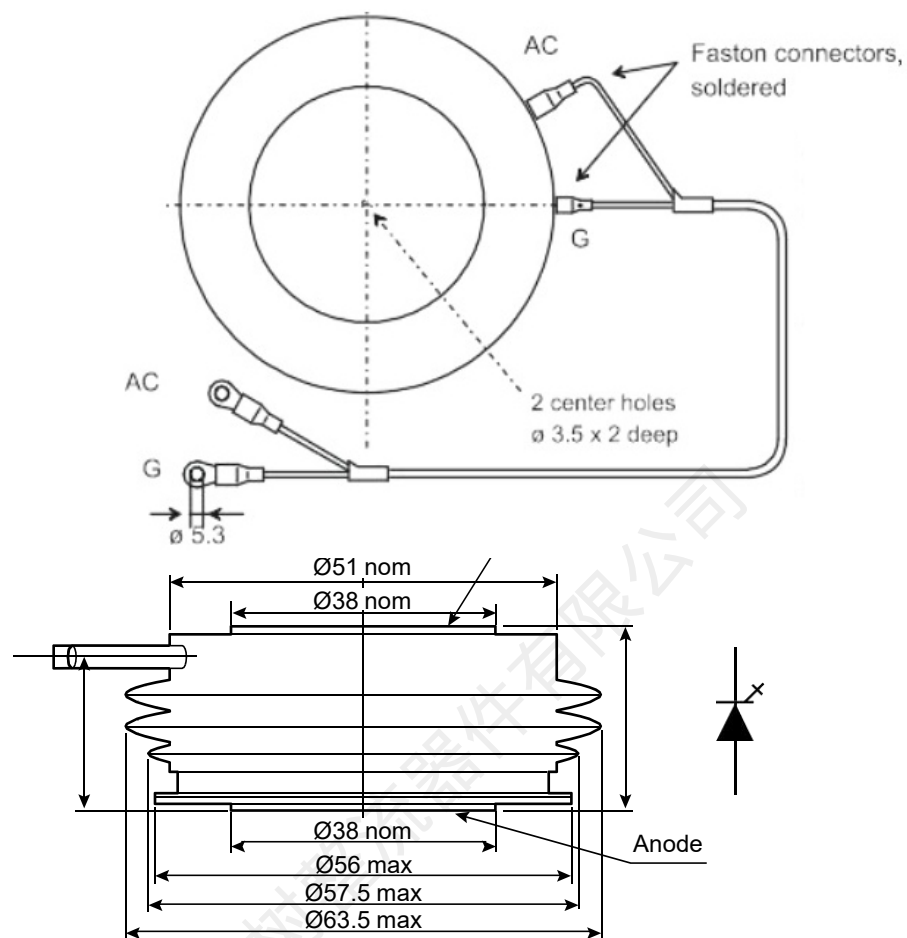
$$V_{RG(min)} = 2V$$

$$V_{RG(max)} = 16V$$

Fig.29 General switching waveforms

产品外形尺寸

For further package information, please contact your local Customer Service Centre. All dimensions in mm, unless stated otherwise.
DO NOT SCALE.



Nominal weight: 350g
Clamping force: 12kN $\pm 10\%$
Lead coaxial, length: 600mm

Package outline type code: P